

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4	("3781596").PN.	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/17 23:20
S1	11759	(leadframe or (lead adj frame) or foil) with (plastic adj (film or layer))	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 20:11
S2	2952	(leadframe or (lead adj frame) or foil) with (diode or photodiode)	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 20:13
S3	12	S1 and S2	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 20:13
S4	6	@ad <= "20030604" and S3	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 20:49
S5	4	(("6523446") or ("5399416")).PN.	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/16 20:53
S6	57309	(leadframe or (lead adj frame) or foil) with (multi-layer or multilayer or (multi adj layer) or laminate or laminated or multi-layered)	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 21:13
S7	4235	S1 and S6	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/16 21:14

S8	3118	@ad <= "20030604" and S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 21:15
S9	775	S8 and package	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 21:17
S10	519034	(die or chip or component or IC or (integrated adj circuit) or (semiconductor adj device) or diode or photodiode) with (encapsulant or encapsulat\$4 or sealant or seal\$3 or mold\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 21:24
S11	141	S9 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 21:25
S12	141	S11 and (plastic adj (film or layer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/16 21:45
S13	43	(leadframe or (lead adj frame) or foil) with (plastic adj (film or layer)) with punch \$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/17 21:37
S14	39	@ad <= "20030604" and S13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/17 21:38
S15	43	(leadframe or (lead adj frame) or foil) with (plastic adj (film or layer)) with punch \$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/17 21:40
S16	39	@ad <= "20030604" and S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/17 21:41

2/18/08 12:13:09 AM

C:\ Documents and Settings\ttran13\ My Documents\ EAST\ Workspaces\ 10519347.wsp